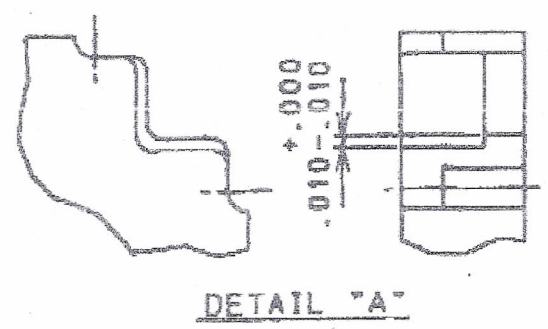
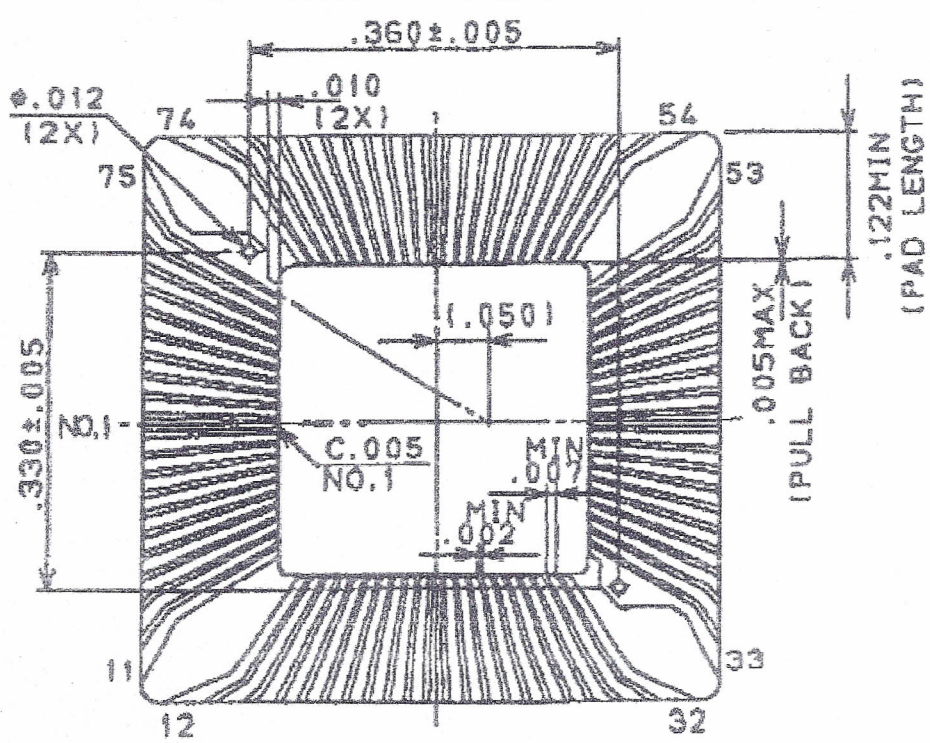
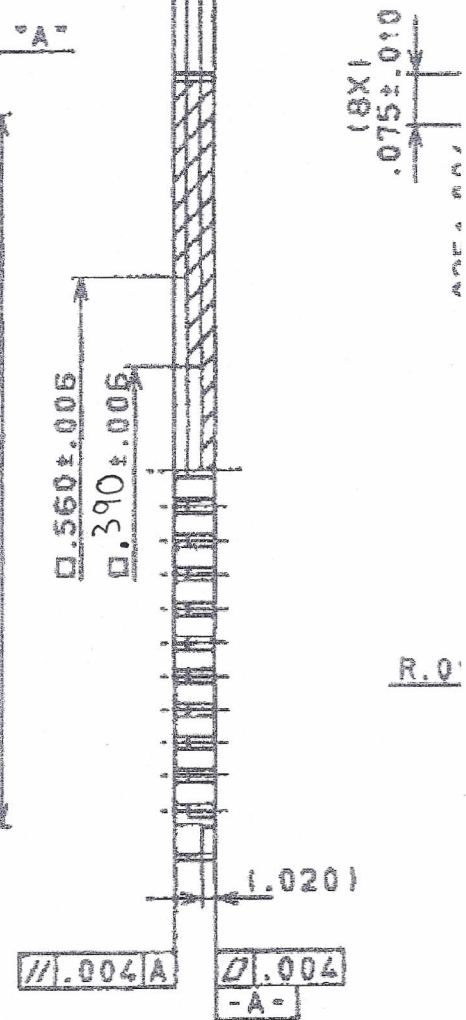
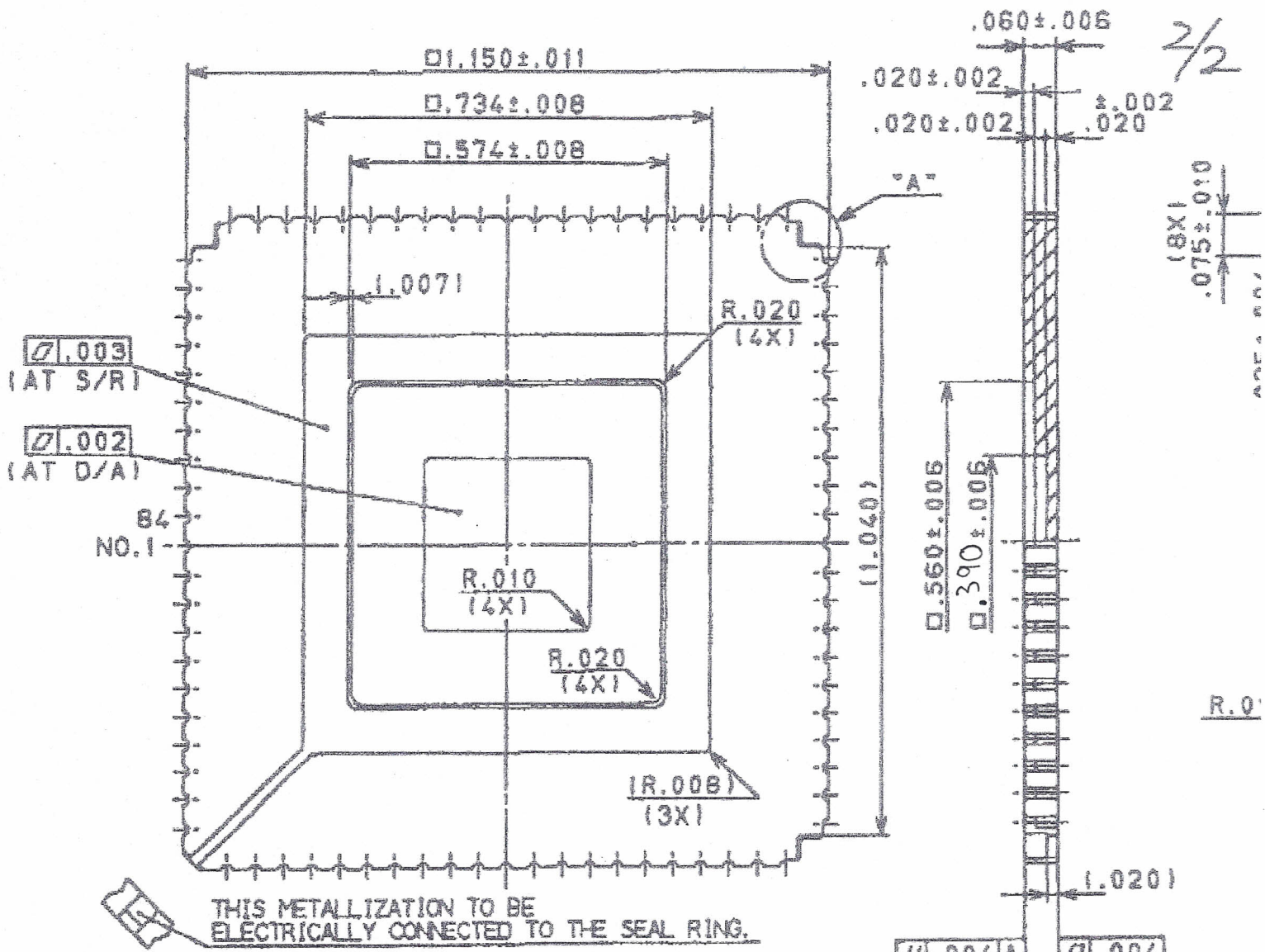


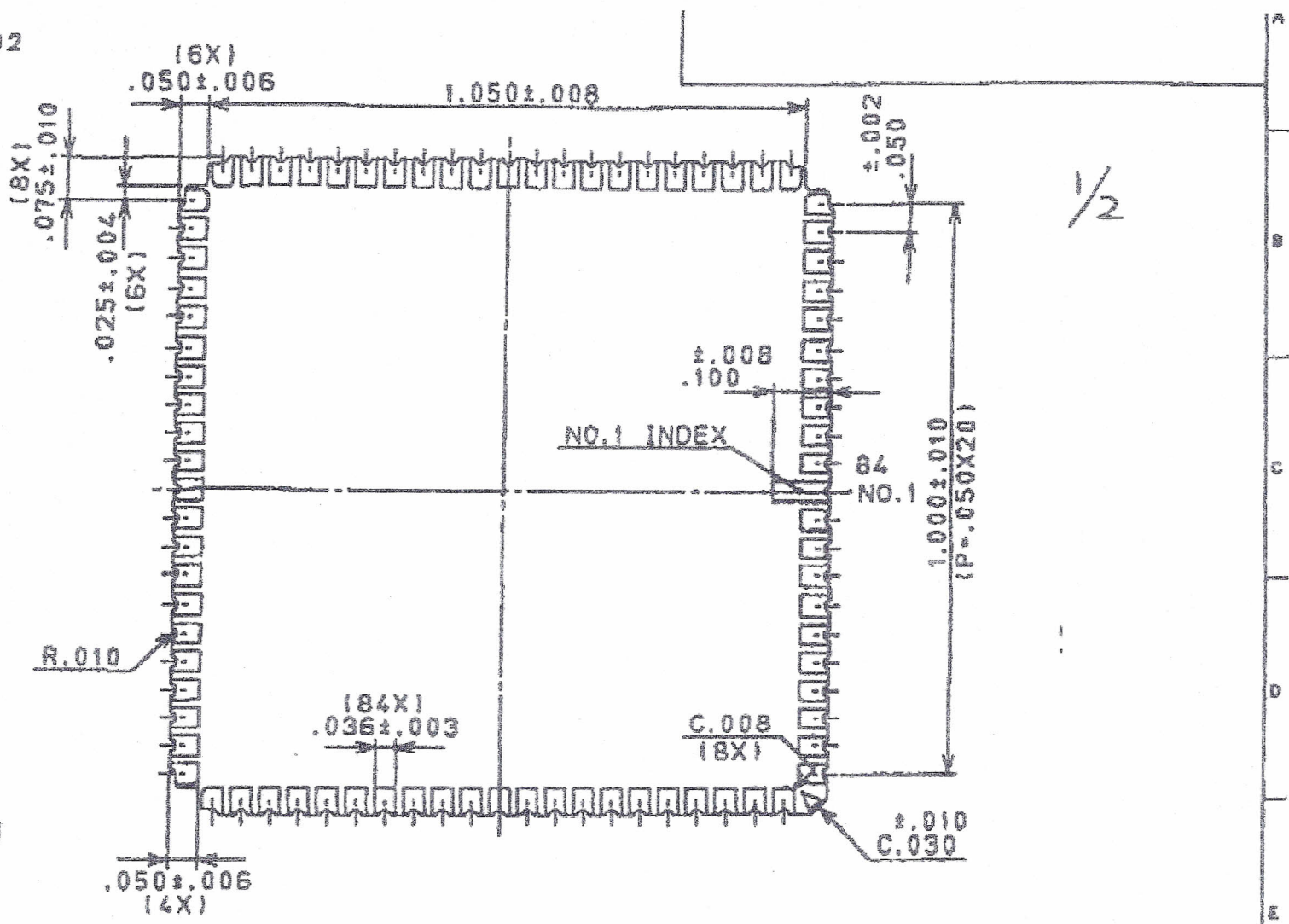
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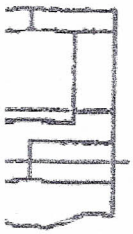
IRK84FI-172F  
 84 LCC .390 sq cavity

B/G PADS DETAIL

002  
20



- NOTES: 1. GOLD PLATE 60 $\mu$  INCHES MIN OVER 80 $\mu$  INCHES MIN NICKEL.  
 2. LEAD RESISTANCE: 300m $\Omega$  MAX.  
 3. NO LEAD TO BE ELECTRICALLY CONNECTED TO THE DIE ATTACH PAD. SEAL RING ISOLATED.



3				8	RE DRAWING	NOV-92
2				A	RE DRAWING	OCT-26-1992
1	CERAMIC	ALUMINA		0	NEW DRAWING	MAR-13-1986
Draw No	Material	Description	Rev.	Description	Date	
UNLESS OTHERWISE SPECIFIED TOLERANCES: ± 1% N. L. T. 3 DECIMALS. DRG ± .01			DESIGN H. HASHIMOTO	NTK TECHNICAL CERAMICS NGK SPARK PLUG CO., LTD		
			CHECKED	TITLE		
			APPROVED JW	84 LEAD CHIP CARRIER		
			UNIT INCH	DRG NO. IRK84FI-172F		
			SCALE	SHEET 1 OF 1		M-H